## **Supporting Information**

## **Optimizing Charge Injection across Transition Metal Dichalcogenide Heterojunctions: Theory and Experiment**

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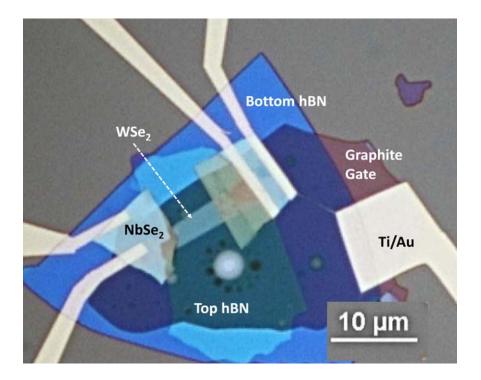


Figure S1. Optical micrograph of a few-layer  $WSe_2$  FET with  $NbSe_2$  drain/source contacts and a graphite gate. The channel is encapsulated between thin *h*BN crystals from top and bottom. The bottom *h*BN layer also serves as the gate dielectric.

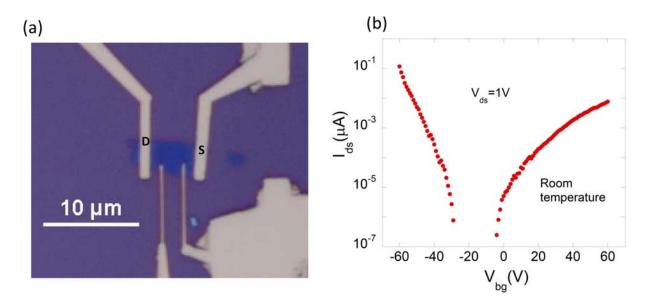


Figure S2. Optical micrograph (a) and transfer characteristic (b) of a comparison device consisting of a few-layer  $WSe_2$  channel and conventional Ti/Au drain and source contacts. The device shows about 2 orders of magnitude lower hole current than our few-layer  $WSe_2$  FETs with  $NbSe_2$  contacts discussed in the main manuscript.